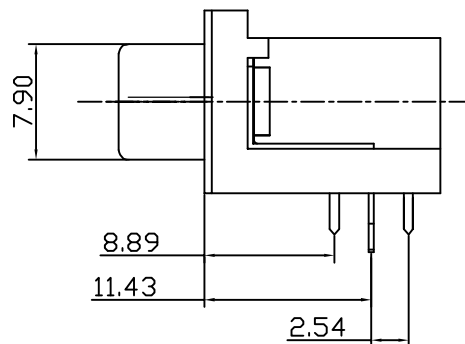
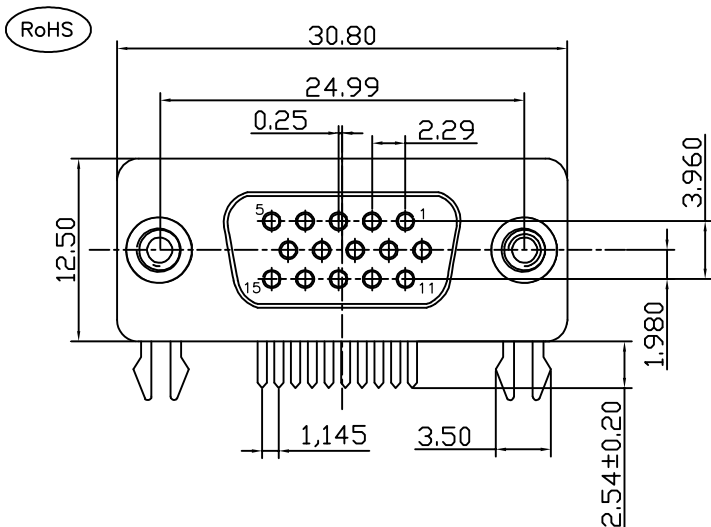


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements



NOTE:

1.MATERIAL:

- 1.1 HOUSING:PBT+30%GF, UL94V-0, COLOR:BLACK OR BLUE.
- 1.2 TERMINAL:COPPER ALLOY.
- 1.3 SHELL:SPCC
- 1.4 RIVET:COPPER ALLOY.
- 1.5 HARPOON:SPCC

2. PLATING:

2.1 CONTACT:

- 80u" Min. TIN PLATED ON SOLDER TAIL
- 50u" Min. NICKEL UNDER-PLATED

2.2 SHELL:50u" Min, NICKEL PLATED OVERALL

2.3 HARPOON:50u" Min, TIN PLATED OVERALL.

2.4 RIVET:50u" Min, NICKEL PLATED OVERALL.

3. SPECIFICATIONS:

VOLTAGE: 250 VAC(RMS) MAX.

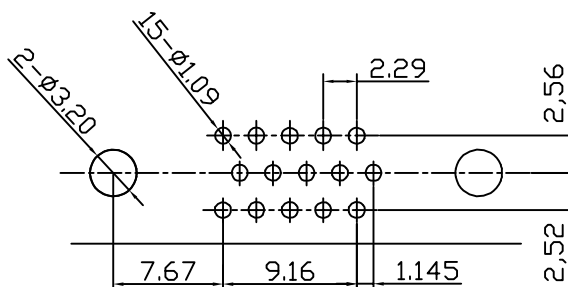
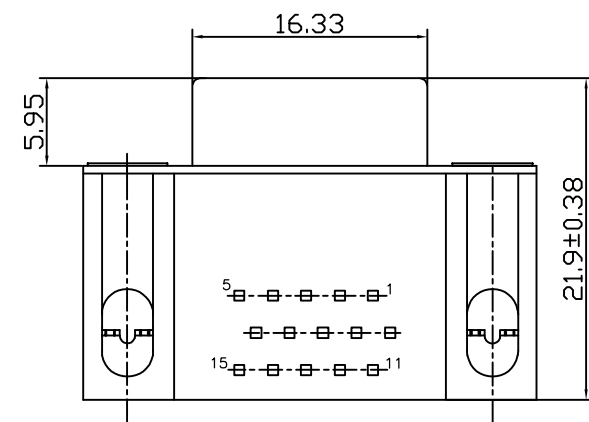
CURRENT RATING: 3 AMPERE PER CONTACT

CONTACT RESISTANCE: 25 MILLIOHMS MAX.

INSULATION RESISTANCE: 1000 MEGOHMS MIN.

DIELECTRIC WITHSTANDING VOLTAGE: 500V AC(RMS)

OPERATING TEMPERATURE:-25? ~ +85?



PCB Holes Diagram(Top View)

P/N:WLDBF9-15 1 X X 0 143

PLATING:
7-Sn

COLOUR:
G-BLUE

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: WLDBF9-151XX0143	DWG.NO: ENDE05	 WanLian Teconology Co., Ltd
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.01.13			
				0.0±0.35	X°REF±6°						
				UNIT:mm	0.00±0.25	X°±3°	DESIGNER	Han_Gao	21.01.13	TITLE: HDR8.89 15F 90°DIP riveting	
			SIZE: A4	0.000±0.10	X°X' ±2°	DRAWN	Zijun_Huang	21.01.13	REV: A0		SHEET: 1/1